

HSF

NOTES:

Current Rating: 1.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 500V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

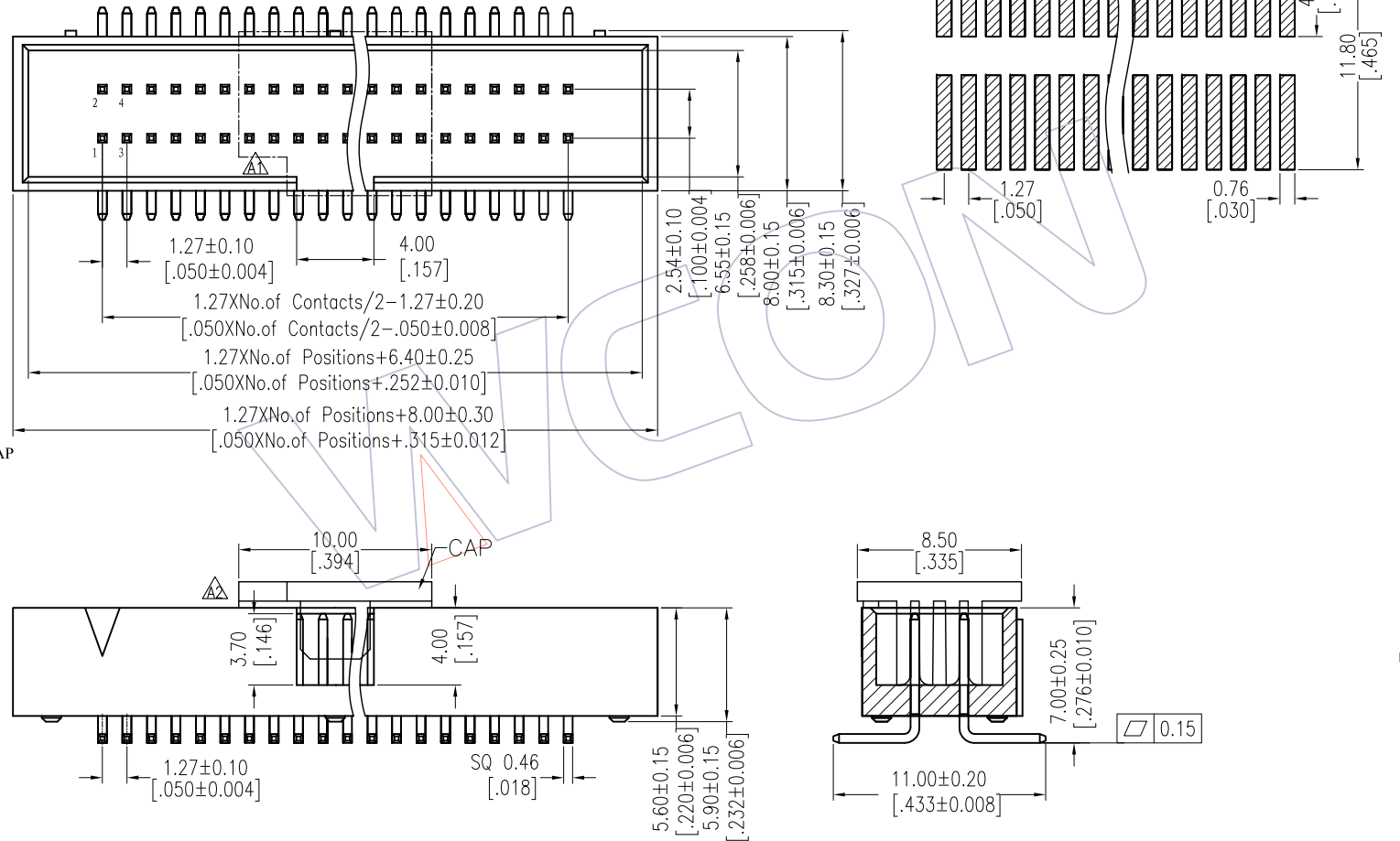
Contact Material: Brass
 Contact plating: Au or Sn Over Ni
 Insulator Material: PA9T+30%GF(UL94V-0)

Ordering Information

3140-XX M XX BK00 X X

No. of Pins	Contact Plating	Color Insulator	Packing
10 34	G0=Gold Flash	B=Black	T=Tube
14 40	G3=10u"Gold	W=White	P=Tube+CAP
16 44	G4=15u"Gold		R=Tapd&Reel+CAP
20 50	G5=30u"Gold		
24 60	S0=Gold Flash/Tin		
26 64	S3=10u"Gold/Tin		
30 80	S4=15u"Gold/Tin		
100	S5=30u"Gold/Tin		
	SN=Tin		

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Item	Pitch	Mating
Standard	1.27X2.54	5242
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A2	2015/06/22	Modify the CAP	△	x.x ±0.40	Allen	2015/06/22	UNIT	mm	3140-XXMXXBK00XX
A1	2015/04/30	Modify the CAP	△	x.xx ±0.25	CHECK	DATE	SIZE	A4	TITLE:
A0	2012/09/18	NEW	---	x.xxx ±0.15	APPROVE	DATE	SHEET	1/1	1.27*2.54 BOX HEADER
				Angle ± 3'			PROJ.	Customer NO.	H=5.6 180° SMT
				DIM TOL					